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PRELIMINARY **CYW43903**

WICED™ IEEE 802.11 a/b/g/n SoC with an Embedded Applications Processor

The Cypress CYW43903 embedded wireless system-on-a-chip (SoC) is uniquely suited for Internet-of-Things applications. It supports all rates specified in the IEEE 802.11 b/g/n specifications.The device includes an ARM Cortex-based applications processor, a single stream IEEE 802.11n MAC/baseband/radio, a power amplifier (PA), and a receive low-noise amplifier (LNA). It also supports optional antenna diversity for improved RF performance in difficult environments.

The CYW43903 is an optimized SoC targeting embedded Internet-of-Things applications in the industrial and medical sensor, home appliance markets. Using advanced design techniques and process technology to reduce active and idle power, the device is designed for embedded applications that require minimal power consumption and a compact size.

The device includes a PMU for simplifying system power topology and allows for direct operation from a battery while maximizing battery life.

Features

Application Processor Features

- ARM Cortex-R4 32-bit RISC processor.
- 1 MB of on-chip SRAM for code and data.
- An on-chip cryptography core
- 640 KB of ROM containing WICED SDK components such as RTOS and TCP/IP stack.
- 17 GPIOs supported.
- Q-SPI serial flash interface to support up to 40 Mbps of peak transfer.
- Support for UART (3), SPI or CSC master, interfaces. (Cypress Serial Control (CSC) is an I^2C -compatible interface.)

Key IEEE 801.11x Features

- Single-band 2.4 GHz IEEE 802.11n compliant.
- Single-stream spatial multiplexing up to 72 Mbps.
- Supports 20 MHz channels with optional SGI.
- Full IEEE 802.11 b/g legacy compatibility with enhanced performance.
- On-chip power and low-noise amplifiers.
- An internal fractional nPLL allows support for a wide range of reference clock frequencies.
- Integrated ARM Cortex-R4 processor with tightly coupled memory for complete WLAN subsystem functionality, mini-

mizing the need to wake up the applications processor for standard WLAN functions (to further minimize power consumption while maintaining the ability to upgrade to future features in the field).

- Software architecture supported by standard WICED SDK allows easy migration from existing discrete MCU designs and to future devices.
- Security support:
	- ❐ WPA and WPA2 (Personal) support for powerful encryption and authentication.
	- ❐ AES and TKIP in hardware for faster data encryption and IEEE 802.11i compatibility.
	- ❐ Reference WLAN subsystem provides Cisco Compatible Extensions (CCX, CCX 2.0, CCX 3.0, CCX 4.0, and CCX 5.0).
	- ❐ Wi-Fi Protected Setup and Wi-Fi Easy-Setup
- Worldwide regulatory support: Global products supported with worldwide design approval.

General Features

- Supports battery voltage range from 3.0V to 4.8V with an internal switching regulator.
- Programmable dynamic power management.
- 6 Kb OTP memory for storing board parameters.
- \blacksquare 151-ball WLBGA (4.91mm x 5.85mm, 0.4 mm pitch).

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Figure 1. Functional Block Diagram

WRF_RFIN_2G

Contents

1. Overview

1.1 Introduction

The Cypress CYW43903 is a single-chip device that provides the highest level of integration for an embedded system-on-a-chip with integrated IEEE 802.11 b/g/n MAC/baseband/radio and a separate ARM Cortex-R4 applications processor. It provides a small formfactor solution with minimal external components to drive down cost for mass volumes and allows for an embedded system with flexibility in size, form, and function. Comprehensive power management circuitry and software ensure that the system can meet the needs of highly embedded systems that require minimal power consumption and reliable operation.

[Figure 2](#page-5-2) shows the interconnect of all the major physical blocks in the CYW43903 and their associated external interfaces, which are described in greater detail in [Applications Subsystem External Interfaces.](#page-17-0)

Figure 2. Block Diagram and I/O

Note: Another SPI interface can be defined by reconfiguring GPIO_8 through GPIO_11 and another CSC interface can be defined by reconfiguring GPIO_12 and GPIO_13 (see [Table 11, "Pin Multiplexing,"](#page-36-1)).

1.1.1 Features

The CYW43903 supports the following features:

- ARM Cortex-R4 clocked at 160 MHz.
- 1 MB of SRAM and 640 KB ROM available for the applications processor.
- One high-speed 4-wire UART interface with operation up to 4 Mbps.
- Two low-speed 2-wire UART interfaces multiplexed on general purpose I/O (GPIO) pins.
- One dedicated CSC¹ interface.

Note: Another CSC interface can be defined by reconfiguring GPIOs. See [Table 11, "Pin Multiplexing,".](#page-36-1)

■ One SPI master interface with operation up to 24 MHz.

Either or both of the SPI interfaces can be used as CSC master interfaces. This is in addition to the two dedicated CSC interfaces. **Note:** In addition to the dedicated CSC interface, the SPI interface can be used as a CSC master interface.

Note: Another SPI interface can be defined by reconfiguring GPIOs. See [Table 11, "Pin Multiplexing,"](#page-36-1).

- One SPI master interface for serial flash.
- Six dedicated PWM outputs.
- 17 GPIOs.
- IEEE 802.11 b/g/n 1×1 2.4 GHz radio.
- Single- and dual-antenna support.

^{1.} Cypress Serial Control (CSC) is an I²C-compatible interface.

1.2 Standards Compliance

The CYW43903 supports the following standards:

- IEEE 802.11n
- IEEE 802.11b
- IEEE 802.11g
- IEEE 802.11d
- IEEE 802.11h
- IEEE 802.11i
- Security:
	- ❐ WEP
	- ❐ WPA Personal
	- ❐ WPA2 Personal
	- ❐ WMM
	- ❐ WMM-PS (U-APSD)
	- ❐ WMM-SA
	- ❐ AES (hardware accelerator)
	- ❐ TKIP (hardware accelerator)
	- ❐ CKIP (software support)
- Proprietary Protocols:
	- ❐ CCXv2
	- ❐ CCXv3
	- ❐ CCXv4
	- ❐ CCXv5
	- ❐ WFAEC

The CYW43903 supports the following additional standards:

- IEEE 802.11r—Fast Roaming (between APs)
- IEEE 802.11w-Secure Management Frames
- IEEE 802.11 Extensions:
- IEEE 802.11e QoS enhancements (already supported as per the WMM specification)
- IEEE 802.11i MAC enhancements
- IEEE 802.11k radio resource measurement

2. Power Supplies and Power Management

2.1 Power Supply Topology

One core buck regulator, multiple LDO regulators, and a power management unit (PMU) are integrated into the CYW43903. All regulators are programmable via the PMU. These blocks simplify power supply design for application and WLAN functions in embedded designs.

A single VBAT (3.0V to 4.8V DC maximum) and VIO supply (1.8V to 3.3V) can be used, with all additional voltages being provided by the regulators in the CYW43903.

The REG ON control signal is used to power up the regulators and take the appropriate sections out of reset. The CBUCK, CLDO, LNLDO, and other regulators power up when any of the reset signals are deasserted. All regulators are powered down only when REG ON is deasserted. The regulators may be turned off/on based on the dynamic demands of the digital baseband.

The CYW43903 provides a low power-consumption mode whereby the CBUCK, CLDO, and LNLDO regulators are shut down. When in this state, the low-power linear regulator (LPLDO1) supplied by the system VIO supply provides the CYW43903 with all required voltages.

2.2 CYW43903 Power Management Unit Features

The CYW43903 supports the following Power Management Unit (PMU) features:

- VBAT to 1.35Vout (550 mA maximum) core buck (CBUCK) switching regulator
- VBAT to 3.3Vout (450 mA maximum) LDO3P3
- 1.35V to 1.2Vout (350 mA maximum) CLDO with bypass mode for deep-sleep
- 1.35V to 1.2Vout (55 mA maximum) LDO for BBPLL
- Additional internal LDOs (not externally accessible)
- PMU internal timer auto-calibration by the crystal clock for precise wake-up timing from the low power-consumption mode.

[Figure 3](#page-9-0) and [Figure 4](#page-10-0) show the regulators and a typical power topology.

CYW43903

2.3 Power Management

The CYW43903 has been designed with the stringent power consumption requirements of mobile devices in mind. All areas of the chip design are optimized to minimize power consumption. Silicon processes and cell libraries were chosen to reduce leakage current and supply voltages. Additionally, the CYW43903 includes an advanced Power Management Unit (PMU) sequencer. The PMU sequencer provides significant power savings by putting the CYW43903 into various power management states appropriate to the environment and activities that are being performed. The power management unit enables and disables internal regulators, switches, and other blocks based on a computation of the required resources and a table that describes the relationship between resources and the time needed to enable and disable them. Power-up sequences are fully programmable. Configurable, free-running counters (running at a 32.768 kHz LPO clock) in the PMU sequencer are used to turn on and turn off individual regulators and power switches. Clock speeds are dynamically changed (or gated altogether) as a function of the mode. Slower clock speeds are used whenever possible.

[Table 2](#page-11-2) provides descriptions for the CYW43903 power modes.

Table 2. CYW43903 Power Modes

2.4 PMU Sequencing

The PMU sequencer minimizes system power consumption. It enables and disables various system resources based on a computation of required resources and a table that describes the relationship between resources and the time required to enable and disable them.

Resource requests can come from several sources: clock requests from cores, the minimum resources defined in the *ResourceMin* register, and the resources requested by any active resource-request timers. The PMU sequencer maps clock requests into a set of resources required to produce the requested clocks.

Each resource is in one of the following four states:

- enabled
- disabled
- transition_on
- transition_off

The timer contains 0 when the resource is enabled or disabled and a nonzero value when in a transition state. The timer is loaded with the time_on or time_off value of the resource after the PMU determines that the resource must be enabled or disabled and decrements on each 32.768 kHz PMU clock. When it reaches 0, the state changes from transition_off to disabled or transition_on to enabled. If the time on value is 0, the resource can transition immediately from disabled to enabled. Similarly, a time off value of 0 indicates that the resource can transition immediately from enabled to disabled. The terms *enable sequence* and *disable sequence* refer to either the immediate transition or the timer load-decrement sequence.

During each clock cycle, the PMU sequencer performs the following actions:

- Computes the required resource set based on requests and the resource dependency table.
- Decrements all timers whose values are nonzero. If a timer reaches 0, the PMU clears the ResourcePending bit of the resource and inverts the ResourceState bit.
- Compares the request with the current resource status and determines which resources must be enabled or disabled.
- Initiates a disable sequence for each resource that is enabled, is no longer being requested, and has no powered-up dependents.
- Initiates an enable sequence for each resource that is disabled, is being requested, and has all of its dependencies enabled.

2.5 Power-Off Shutdown

The CYW43903 provides a low-power shutdown feature that allows the device to be turned off while the host, and any other system devices remain operational. When the CYW43903 is not needed in the system, VDDIO_RF and VDDC are shut down while VDDIO remains powered. This allows the CYW43903 to be effectively off while keeping the I/O pins powered so that they do not draw extra current from devices connected to the I/O.

During a low-power shutdown state, provided VDDIO remains applied to the CYW43903, all outputs are tristated and most inputs signals are disabled. Input voltages must remain within the limits defined for normal operation. This is done to prevent current paths or create loading on any digital signals in the system, and enables the CYW43903 to be fully integrated in an embedded device while taking full advantage of the lowest power-saving modes.

When the CYW43903 is powered on from this state, it is the same as a normal power-up and does not retain any information about its state from before it was powered down.

2.6 Power-Up/Power-Down/Reset Circuits

The CYW43903 has two signals (see [Table 3](#page-12-2)) that enable or disable circuits and the internal regulator blocks, allowing the host to control power consumption. For timing diagrams of these signals and the required power-up sequences, see [Power-Up Sequence](#page-60-0) [and Timing.](#page-60-0)

Table 3. Power-Up/Power-Down/Reset Control Signals

3. Frequency References

An external crystal is used for generating all radio frequencies and normal-operation clocking. As an alternative, an external frequency reference can be used. In addition, a low-power oscillator (LPO) is provided for lower power mode timing.

3.1 Crystal Interface and Clock Generation

The CYW43903 can use an external crystal to provide a frequency reference. The recommended crystal oscillator configuration, including all external components, is shown in [Figure 5](#page-13-2). Consult the reference schematics for the latest configuration.

A fractional-N synthesizer in the CYW43903 generates the radio frequencies, clocks, and data/packet timing, enabling it to operate using a wide selection of frequency references.

The recommended default frequency reference is a 37.4 MHz crystal. The signal characteristics for the crystal interface are listed in [Table 4.](#page-14-1)

Note: Although the fractional-N synthesizer can support alternative reference frequencies, frequencies other than the default require support to be added in the driver, plus additional extensive system testing. Contact Cypress for further details.

3.2 External Frequency Reference

As an alternative to a crystal, an external precision frequency reference can be used, provided that it meets the phase noise requirements listed in [Table 4.](#page-14-1)

If used, the external clock should be connected to the WRF_XTAL_XON pin through an external 1000 pF coupling capacitor, as shown in [Figure 6](#page-14-2). The internal clock buffer connected to this pin will be turned off when the CYW43903 goes into sleep mode. When the clock buffer turns on and off, there will be a small impedance variation. Power must be supplied to the WRF_XTAL_VDD1P35 pin.

Figure 6. Recommended Circuit to Use With an External Reference Clock

Table 4. Crystal Oscillator and External Clock—Requirements and Performance

1. (Crystal) Use WRF_XTAL_XON and WRF_XTAL_XOP.

2. See [External Frequency Reference](#page-14-0) for alternative connection methods.

3. It is the responsibility of the equipment designer to select oscillator components that comply with these specifications.

4. Assumes that external clock has a flat phase noise response above 100 kHz.

3.3 External 32.768 kHz Low-Power Oscillator

The CYW43903 uses a secondary low frequency clock for low-power-mode timing. Either the internal low-precision LPO or an external 32.768 kHz precision oscillator is required. The internal LPO frequency range is approximately 33 kHz ± 30% over process, voltage, and temperature, which is adequate for some applications. However, one tradeoff caused by this wide LPO tolerance is a small current consumption increase during power save mode that is incurred by the need to wake-up earlier to avoid missing beacons.

Whenever possible, the preferred approach is to use a precision external 32.768 kHz clock that meets the requirements listed in [Table 5.](#page-15-1)

Table 5. External 32.768 kHz Sleep Clock Specifications

1. When power is applied or switched off.

4. Applications Subsystem

4.1 Overview

The Applications subsystem contains the general use CPU, memory, the standalone DMA core, the cryptography core, and the majority of the external interfaces.

4.2 Applications CPU and Memory Subsystem

This subsystem has an integrated 32-bit ARM Cortex-R4 processor with an internal 32 KB D-cache and an internal 32 KB I-cache. The ARM Cortex-R4 is a low-power processor that features a low gate count, low interrupt latency, and low-cost debugging capabilities. It is intended for deeply embedded applications that require fast interrupt response features. The ARM Cortex-R4 implements the ARM v7-R architecture and supports the Thumb-2 instruction set.

At 0.19 µW/MHz, the Cortex-R4 is the most power efficient general-purpose microprocessor available, outperforming 8- and 16-bit devices on a MIPS/µW basis. It also supports integrated sleep modes.

Using multiple technologies to reduce cost, the ARM Cortex-R4 enables improved memory utilization, reduced pin overhead, and reduced silicon area. It also has extensive debugging features, including real-time tracing of program execution.

On-chip memory for the CPU includes 1 MB SRAM, 640 KB ROM, and an 8 KB RAM powered independently of the application subsystem.

4.3 Memory-to-Memory DMA Core

The CYW43903 memory-to-memory DMA (M2MDMA) engine contains eight DMA channel pairs, each containing one transmit/pull engine and one receive/push engine.

The DMA engine provides general purpose data movement between memories that can be on the device, attached directly to the device, or accessed through a host interface. The transmit/pull engine reads data from the source memory and immediately passes it to the paired receive/push engine, which proceeds to write it to the destination memory. Multiple masters can program the individual channels, and multiple interrupts are provided so that interrupts for different channels can be routed separately to different masters.

4.4 Cryptography Core

This core provides general purpose data movement between memories, which may be either on the device, attached directly to the device, or accessed through a host interface. The transmit/pull engine reads data from the source memory and passes it immediately to the paired receive/push engine that proceeds to write it to the destination memory. Multiple masters may program the individual channels, and multiple interrupts are provided so that interrupts for different channels can be routed separately to different masters.

The cryptography block provides a hardware accelerator for enciphering and deciphering data that has undergone processing using standards-based encryption algorithms. The cryptography block includes the following primary features:

- Encryption and hash engines that support single pass AUTH-ENC or ENC-AUTH processing.
- A scalable AES module that supports CBC, ECB, CTR, CFB, OFB, and XTS encryption with 128-, 192-, and 256-bit key sizes.
- A scalable DES module that supports DES and 3DES in ECB and CBC modes.
- An RC4 stream cipher module that supports state initialization, state update, and key-stream generation.
- MD5, SHA1, SHA224, and SHA256 engines that support pure hash or HMAC operations.
- A built-in 512-byte key cache for locally protected key storage.

OTP memory is used to store authentication keys.

5. Applications Subsystem External Interfaces

5.1 GPIO

There are 17 general-purpose I/O (GPIO) pins available on the CYW43903. The GPIOs can be used to connect to various external devices.

Upon power-up and reset, these pins are tristated. Subsequently, they can be programmed to be either input or output pins via the GPIO control register. In addition, the GPIO pins can be assigned to various other functions.

Apart from other functions, GPIOs are used to set bootstrap options and use the JTAG interface for debugging during software development.

5.2 Cypress Serial Control

The CYW43903 has two Cypress Serial Control (CSC²) master interfaces for external communication with codecs, DACs, NVRAM, etc. The I/O pads can be configured as pull-ups or pull-ups can be installed on the reference design to support a multimaster on an open drain bus.

5.3 JTAG and ARM Serial Wire Debug

The CYW43903 supports the IEEE 1149.1 JTAG boundary scan standard for performing device package and PCB assembly testing during manufacturing. In addition, the JTAG interface allows Cypress to assist customers by using proprietary debug and characterization test tools during board bring-up. Therefore, it is highly recommended to provide access to the JTAG pins by means of test points or a header on all PCB designs.

The CYW43903 also supports ARM Serial Wire Debug (SWD) for connecting a JTAG debugger directly to both ARM Cortex-R4s. For SWD, the combination of a clock and a bidirectional signal (on a single pin) provides normal JTAG debug and test functionality. The reduced pin-count SWD interface is a high-performance alternative to the JTAG interface.

[Table 6](#page-17-4) shows the JTAG_SEL and TAP_SEL states for test and debug function selection. Test and debug function selection is independent of the debugging interface (JTAG or SWD) being used.

Table 6. JTAG_SEL and TAP_SEL States for Test and Debug Function Selection

Note: JTAG_SEL is exposed on a dedicated physical pin. TAP_SEL uses the GPIO_8 physical pin.

^{2.} Cypress Serial Control is an I^2C compatible interface.

5.4 PWM

The CYW43903 provides up to six independent pulse width modulation (PWM) channels. The following features apply to the PWM channels:

- Each channel is a square wave generator with a programmable duty cycle.
- Each channel generates its duty cycle by dividing down the input clock.
- Both the high and low duration of the duty cycle can be divided down independently by a 16-bit divider register.
- Each channel can work independently or update simultaneously.
- Pairs of PWM outputs can be inverted for devices that need a differential output.
- Continuous or single pulses can be generated.
- The input clock can either be a high-speed clock from a PLL channel or a lower speed clock at the crystal frequency.

5.5 SPI Flash

The SPI flash interface supports the following features:

- A SPI-compatible serial bus.
- An 80 MHz (maximum) clock frequency.
- Increased Throughput to 40 MBps in Quad-mode or upto 10 MBps in single Mode 3 .
- Support for either ×1 or ×4 addresses with ×4 data.
- 3-bytes and 4-byte addressing modes.
- A configurable dummy-cycle count that is programmable from 1 to 15.
- Programmable instructions output to serial flash.
- An option to change the sampling edge from rising-edge to falling-edge for read-back data when in high-speed mode.

5.6 UART

A high-speed 4-wire CTS/RTS UART interface can be enabled by software and has dedicated pins. Provided primarily for debugging during development, this UART enables the CYW43903 to operate as RS-232 data termination equipment (DTE) for exchanging and managing data with other serial devices. It is compatible with the industry standard 16550 UART and provides a FIFO size of 64 × 8 in each direction.

There are two low-speed UART interfaces on the CYW43903. Each functions as a standard 2-wire UART. They are also enabled as alternate functions on GPIOs and can be enabled independently of the 4-wire fast UART.

Note: The high-speed, 4-wire UART interface is identified as UART0 in this document and in reference schematics. The two lowspeed, 2-wire UART interfaces are identified as UART1 and UART2 in this document and in the reference schematics.

^{3.} Note that the clock needs to be constrained to ∼26.67MHz for reliable operation at high operating temperatures. The throughput of the SPI Flash block is
therefore restricted to ∼13 MBps for Quad mode and ∼3 MBps for si

5.7 SPI

CYW43903 contains one SPI block. This block support a fixed SPI mode (CPOL = 0, CPHA = 0) and 8-bit data read/write.

- CPOL = 0: Clock idles at 0, and each cycle consists of a pulse of 1. The leading edge is a rising edge, and the trailing edge is a falling edge.
- CPHA = 0: The "out" side changes the data on the trailing edge of the preceding clock cycle, while the "in" side captures the data on (or shortly after) the leading edge of the clock cycle.

The SPI hardware block supports a hold time of 25ns and a maximum clock frequency of 40MHz. If a SPI slave does not support the above mode or requires a hold time greater than 25ns, a bit banging software SPI driver should be used. Cypress's WICED SDK provides and example of such a driver.

Note that the maximum SPI frequency support by a software SPI driver is much lower than 40 MHz.

SPI0 mentioned in [Table 8](#page-30-1) is multiplexed with GPIOs and can therefore support a bit banging based software SPI driver.

6. Global Functions

6.1 External Coexistence Interface

An external handshake interface is available to enable signaling between the device and an external colocated wireless device, such as Bluetooth, to manage wireless medium sharing for optimum performance.

Figure 7. Cypress 2-Wire External Coexistence Interface

[Figure 7](#page-20-4) shows the coexistence interface.

Note: SECI UART is the same as UART2, one of the low-speed UART interfaces mentioned in section 5.7 and in the reference schematics.

6.2 One-Time Programmable Memory

Various hardware configuration parameters can be stored in an internal 6144-bit (768 bytes) One-Time Programmable (OTP) memory that is read by system software after a device reset. In addition, customer-specific parameters, including the system vendor ID and MAC address can be stored, depending on the specific board design.

The initial state of all bits in an unprogrammed OTP memory device is 0. After any bit is programmed to a 1, it cannot be reprogrammed to 0. The entire OTP memory array can be programmed in a single write-cycle using a utility provided with the Cypress WLAN manufacturing test tools. Alternatively, multiple write cycles can be used to selectively program specific bytes, but only bits that are still in the 0 state can be altered during each programming cycle.

Prior to OTP memory programming, all values should be verified using the appropriate editable nvram.txt file. The nvram.txt file is provided with the reference board design package.

6.3 Hibernation Block

The Hibernation (HIB) block is a self-contained power domain that can be used to completely shut down the rest of the CYW43903. This optional block uses the HIB_REG_ON_OUT pin to drive the REG_ON pin. Therefore, for the HIB block to work as designed, the HIB_REG_ON_OUT pin must be connected to the REG_ON pin. To use the HIB block, software programs the HIB block with a wake count and then asserts a signal indicating that the chip should be put into hibernation. After assertion, the HIB block drives HIB_REG_ON_OUT low for the number of 32 kHz clock cycles programmed as the wake count. After the wake-count timer expires, HIB_REG_ON_OUT is driven high. Other than the logic state of the HIB block, no state is saved in the CYW43903 during hibernation.

6.4 System Boot Sequence

The following general sequence occurs after a CYW43903 is powered on:

1. Either REG_ON or HIB_REG_ON_IN is asserted.

Note: For HIB_REG_ON_IN to function as intended, HIB_REG_ON_OUT must be connected to REG_ON.

- 2. The core LDO (CLDO) and LDO3P3 outputs stabilize.
- 3. The OTP memory bits are used to initialize various functions, such as PMU trimming, package selection, memory size selection, etc.
- 4. The APP and WLAN cores are powered up.
- 5. The XTAL is powered up.
- 6. The APP and WLAN CPU bootup sequences start.

7. Wireless LAN Subsystem

7.1 WLAN CPU and Memory Subsystem

The CYW43903 WLAN section includes an integrated 32-bit ARM Cortex-R4 processor with internal RAM and ROM. The ARM Cortex-R4 is a low-power processor that features a low gate count, a small interrupt latency, and low-cost debug capabilities. It is intended for deeply embedded applications that require fast interrupt response features. Delivering more than a 30% performance gain over ARM7TDMI, the ARM Cortex-R4 implements the ARM v7-R architecture with support for the Thumb-2 instruction set.

At 0.19 µW/MHz, the Cortex-R4 is the most power efficient general-purpose microprocessor available, outperforming 8- and 16-bit devices on MIPS/µW. It also supports integrated sleep modes.

On-chip memory for this CPU includes 576 KB of SRAM and 448 KB of ROM.

7.2 IEEE 802.11n MAC

The CYW43903 WLAN media access controller (MAC) is designed to support high-throughput operation with low power consumption. It does so without compromising the Bluetooth coexistence policies, thereby enabling optimal performance over both networks. In addition, several power-saving modes have been implemented that allow the MAC to consume very little power while maintaining network-wide timing synchronization. The architecture diagram of the MAC is shown in [Figure 8.](#page-22-3)

The following sections provide an overview of the important MAC modules.

Figure 8. WLAN MAC Architecture

The CYW43903 WLAN MAC supports features specified in the IEEE 802.11 base standard and amended by IEEE 802.11n. The key MAC features include:

- Transmission and reception of aggregated MPDUs (A-MPDU) for high throughput (HT).
- Support for power management schemes, including WMM power-save, power-save multi-poll (PSMP), and multiphase PSMP operation.
- Support for immediate ACK and Block-ACK policies.
- Interframe space timing support, including RIFS.

- Support for RTS/CTS and CTS-to-self frame sequences for protecting frame exchanges.
- Back-off counters in hardware for supporting multiple priorities as specified in the WMM specification.
- Timing synchronization function (TSF), network allocation vector (NAV) maintenance, and target beacon transmission time (TBTT) generation in hardware.
- Hardware offload for AES-CCMP, legacy WPA TKIP, legacy WEP ciphers, WAPI, and support for key management.
- Support for coexistence with Bluetooth and other external radios.
- Programmable independent basic service set (IBSS) or infrastructure basic service set functionality.
- Statistics counters for MIB support.

7.2.1 PSM

The programmable state machine (PSM) is a microcoded engine that provides most of the low-level control to the hardware in order to implement the IEEE 802.11 specification. It is a microcontroller that is highly optimized for flow-control operations, which are predominant in implementations of communication protocols. The instruction set and fundamental operations are simple and general, allowing algorithms to be optimized very late in the design process. It also allows for changes to the algorithms to track evolving IEEE 802.11 specifications.

The PSM fetches instructions from microcode memory. It uses the shared memory to obtain operands for instructions, as a data store, and to exchange data between both the host and the MAC data pipeline (via the SHM bus). The PSM also uses a scratch-pad memory (similar to a register bank) to store frequently accessed and temporary variables.

The PSM exercises fine-grained control over the hardware engines by programming internal hardware registers (IHR). These IHRs are colocated with the hardware functions they control and are accessed by the PSM via the IHR bus.

The PSM fetches instructions from the microcode memory using an address determined by the program counter, instruction literal, or a program stack. For ALU operations, the operands are obtained from shared memory, scratch-pad memory, IHRs, or instruction literals, and the results are written into the shared memory, scratch-pad memory, or IHRs.

There are two basic branch instructions: conditional branches and ALU-based branches. To better support the many decision points in the IEEE 802.11 algorithms, branches can depend on either readily available signals from the hardware modules (branch condition signals are available to the PSM without polling the IHRs) or on the results of ALU operations.

7.2.2 WEP

The wired equivalent privacy (WEP) engine encapsulates all the hardware accelerators to perform encryption and decryption as well as MIC computation and verification. The accelerators implement the following cipher algorithms: legacy WEP, WPA TKIP, WPA2 AES-CCMP.

The PSM determines, based on the frame type and association information, the appropriate cipher algorithm to use. It supplies the keys to the hardware engines from an on-chip key table. The WEP interfaces with the transmit engine (TXE) to encrypt and compute the MIC on transmit frames and the receive engine (RXE) to decrypt and verify the MIC on receive frames.

7.2.3 TXE

The transmit engine (TXE) constitutes the transmit data path of the MAC. It coordinates the DMA engines to store the transmit frames in the TXFIFO. It interfaces with the WEP module to encrypt frames and transfers the frames across the MAC-PHY interface at the appropriate time determined by the channel-access mechanisms.

The data received from the DMA engines are stored in transmit FIFOs. The MAC has multiple logical queues to support traffic streams that have different QoS priority requirements. The PSM uses the channel access information from the IFS module to schedule a queue from which the next frame is transmitted. Once the frame is scheduled, the TXE hardware transmits the frame based on a precise timing trigger received from the IFS module.

The TXE module also contains the hardware that allows the rapid assembly of MPDUs into an A-MPDU for transmission. The hardware module aggregates the encrypted MPDUs by adding appropriate headers and pad delimiters as needed.

7.2.4 RXE

The receive engine (RXE) constitutes the receive data path of the MAC. It interfaces with the DMA engine to drain the received frames from the RXFIFO. It transfers bytes across the MAC-PHY interface and interfaces with the WEP module to decrypt frames. The decrypted data is stored in the RXFIFO.

The RXE module contains filters that are programmed by the PSM to accept or filter frames based on several criteria such as receiver address, BSSID, and certain frame types.

The RXE module also contains the hardware required to detect A-MPDUs, parse the headers of the containers, and disaggregate them into component MPDUS.

7.2.5 IFS

The IFS module contains the timers required to determine interframe-space timing including RIFS timing. It also contains multiple backoff engines required to support prioritized access to the medium as specified by WMM.

The interframe-spacing timers are triggered by the cessation of channel activity on the medium, as indicated by the PHY. These timers provide precise timing to the TXE to begin frame transmission. The TXE uses this information to send response frames or perform transmit frame-bursting (RIFS or SIFS separated, as within a TXOP).

The backoff engines (for each access category) monitor channel activity, in each slot duration, to determine whether to continue or pause the backoff counters. When the backoff counters reach 0, the TXE gets notified so that it may commence frame transmission. In the event of multiple backoff counters decrementing to 0 at the same time, the hardware resolves the conflict based on policies provided by the PSM.

The IFS module also incorporates hardware that allows the MAC to enter a low-power state when operating under the IEEE power save mode. In this mode, the MAC is in a suspended state with its clock turned off. A sleep timer, whose count value is initialized by the PSM, runs on a slow clock and determines the duration over which the MAC remains in this suspended state. When the timer expires, the MAC is restored to its functional state. The PSM updates the TSF timer based on the sleep duration, ensuring that the TSF is synchronized to the network.

The IFS module also contains the PTA hardware that assists the PSM in Bluetooth coexistence functions.

7.2.6 TSF

The timing synchronization function (TSF) module maintains the TSF timer of the MAC. It also maintains the target beacon transmission time (TBTT). The TSF timer hardware, under the control of the PSM, is capable of adopting timestamps received from beacon and probe response frames in order to maintain synchronization with the network.

The TSF module also generates trigger signals for events that are specified as offsets from the TSF timer, such as uplink and downlink transmission times used in PSMP.

7.2.7 NAV

The network allocation vector (NAV) timer module is responsible for maintaining the NAV information conveyed through the duration field of MAC frames. This ensures that the MAC complies with the protection mechanisms specified in the standard.

The hardware, under the control of the PSM, maintains the NAV timer and updates the timer appropriately based on received frames. This timing information is provided to the IFS module, which uses it as a virtual carrier-sense indication.

7.2.8 MAC-PHY Interface

The MAC-PHY interface consists of a data path interface to exchange RX/TX data from/to the PHY. In addition, there is an programming interface that can be controlled either by the host or the PSM to configure and control the PHY.

7.3 IEEE 802.11™ b/g/n PHY

The CYW43903 WLAN digital PHY complies with IEEE 802.11b/g/n single-stream specifications to provide wireless LAN connectivity supporting data rates from 1 Mbps to 72 Mbps for low-power, high-performance, handheld applications.

The PHY has been designed to work in the presence of interference, radio nonlinearity, and various other impairments. It incorporates optimized implementations of filters, FFTs, and Viterbi-decoder algorithms. Efficient algorithms have been designed to achieve maximum throughput and reliability, including algorithms for carrier sensing and rejection, frequency/phase/timing acquisition and tracking, and channel estimation and tracking. The PHY receiver also contains a robust IEEE 802.11b demodulator. The PHY carriersensing algorithm provides high throughput for IEEE 802.11b/g hybrid networks with Bluetooth coexistence.

The key PHY features include:

- Programmable data rates from MCS0-7 in 20 MHz channels.
- Support for Optional Short GI and Green Field modes in TX and RX.
- All scrambling, encoding, forward error correction, and modulation in the transmit direction and inverse operations in the receive direction.
- Support for IEEE 802.11h/k for worldwide operation.
- Advanced algorithms for low power consumption and enhanced sensitivity, range, and reliability.
- Algorithms to improve performance in the presence of externally received Bluetooth signals.
- An automatic gain control scheme for blocking and nonblocking cellular applications.
- Closed loop transmit power control.
- Digital RF chip calibration algorithms to handle CMOS RF chip process, voltage, and temperature (PVT) variations.
- On-the-fly channel frequency and transmit power selection.
- Per-packet RX antenna diversity.
- Available per-packet channel quality and signal-strength measurements.
- Compliance with FCC and other worldwide regulatory requirements.

Figure 9. WLAN PHY Block Diagram

8. WLAN Radio Subsystem

The CYW43903 includes an integrated WLAN RF transceiver that has been optimized for use in 2.4 GHz Wireless LAN systems. It has been designed to provide low-power, low-cost, and robust communications for applications operating in the globally available 2.4 GHz unlicensed ISM band. The transmit and receive sections include all on-chip filtering, mixing, and gain control functions.

Ten RF control signals are available to drive external RF switches. See the reference board schematics for more information.

A block diagram of the radio subsystem is shown in [Figure 10.](#page-26-4) Note that integrated on-chip baluns (not shown) convert the fully differential transmit and receive paths to single-ended signal pins.

8.1 Receiver Path

The CYW43903 has a wide dynamic range, direct conversion receiver that employs high-order on-chip channel filtering to ensure reliable operation in the noisy 2.4 GHz ISM band. The 2.4 GHz path has a dedicated on-chip low-noise amplifier (LNA).

8.2 Transmit Path

Baseband data is modulated and upconverted to the 2.4 GHz ISM band. Linear on-chip power amplifiers deliver high output powers while meeting IEEE 802.11b/g/n specifications without the need for external PAs. When using the internal PA, which is required in the 2.4 GHz band, closed-loop output power control is completely integrated.

8.3 Calibration

The CYW43903 features dynamic and automatic on-chip calibration to continually compensate for temperature and process variations across components. These calibration routines are performed periodically during the course of normal radio operation. Examples of some of the automatic calibration algorithms are baseband filter calibration for optimum transmit and receive performance and LOFT calibration for carrier leakage reduction. In addition, I/Q calibration and VCO calibration are performed on-chip. No per-board calibration is required during manufacturing testing. This helps to minimize the test time and cost in large-volume production environments.

Figure 10. Radio Functional Block Diagram

9. Pinout and Signal Descriptions

9.1 Ball Map

Figure 11. 151-Ball WLBGA Map—Top View with Balls Facing Down

9.2 Ball List

[Table 7](#page-28-1) contains the 151-ball WLBGA net names.

Table 7. WLBGA Net Names

┱

9.3 Signal Descriptions

[Table 8](#page-30-1) provides the signal name, type, and description for each CYW43903 ball. The symbols shown under Type indicate pin directions (I/O = bidirectional, I = input, and O = output) and the internal pull-up/pull-down characteristics (PU = weak internal pull-up resistor and PD = weak internal pull-down resistor), if any.

Table 8. Signal Descriptions

Table 8. Signal Descriptions (Cont.)

Table 8. Signal Descriptions (Cont.)

Table 8. Signal Descriptions (Cont.)

10. GPIO Signals and Strapping Options

10.1 Overview

This section describes GPIO signals and strapping options. The pins are sampled at power-on reset (POR) to determine various operating modes. Sampling occurs a few milliseconds after an internal POR or deassertion of the external POR. After the POR, each pin assumes the GPIO or alternative function specified in [Table 10.](#page-35-1) Each strapping option pin has an internal pull-up (PU) or pull-down (PD) resistor that determines the default mode. To change the mode, connect an external PU resistor to VDDIO or a PD resistor to ground, using a 10 kΩ resistor or less.

Note: Refer to the reference board schematics for more information.

10.2 Weak Pull-Down and Pull-Up Resistances

At VDDO = 3.3V ±10%, the minimum, typical, and maximum weak pull-down resistances (for a pin voltage of VDDO) are 37.99 kΩ, 44.57 kΩ, and 51.56 kΩ, respectively. At VDDO = 3.3V ±10%, the minimum, typical, and maximum weak pull-up resistances (for a pin voltage of 0V) are 34.73 kΩ, 39.58 kΩ, and 44.51 kΩ, respectively.

10.3 Strapping Options

[Table 9](#page-34-4) provides the strapping options.

Table 9. Strapping Options

10.4 Alternate GPIO Signal Functions

[Table 10](#page-35-1) provides the alternate signal functions of the GPIO signals.

Table 10. Alternate GPIO Signal Functions

11. Pin Multiplexing

[Table 11](#page-36-2) shows the pin multiplexing functions.

Table 11. Pin Multiplexing

Table 11. Pin Multiplexing

1. UART_DBG_TX and UART_DBG_RX are for UART1 mentioned in section 5.7 and in the reference schematics. SECI_IN and SECI_OUT are for UART2 mentioned in section 5.7 and in the reference schematics.

12. I/O States

[Table 12](#page-38-1) provides I/O state information for the signals listed.

The following notations are used in [Table 12:](#page-38-1)

- I: Input signal
- O: Output signal
- I/O: Input/Output signal
- \blacksquare PU = Pulled up
- PD = Pulled down
- NoPull = Neither pulled up nor pulled down

Table 12. I/O States

Table 12. I/O States

1. Keeper column: N = pad has no keeper. Y = pad has a keeper. Keeper is always active except in power-down state. If there is no keeper, and it is an input and there is NoPull, then the pad should be driven to prevent leakage due to floating pad (WL_REG_ON, for example).

2. In the power-down state (xx_REG_ON=0): High-Z; NoPull => the pad is disabled because power is not supplied.

13. Electrical Characteristics

Note: Values in this data sheet are design goals and are subject to change based on the results of device characterization.

13.1 Absolute Maximum Ratings

Caution! The absolute maximum ratings in [Table 13](#page-40-2) indicate levels where permanent damage to the device can occur, even if these limits are exceeded for only a brief duration. Functional operation is not guaranteed under these conditions. Operation at absolute maximum conditions for extended periods can adversely affect long-term reliability of the device.

Table 13. Absolute Maximum Ratings

1. For the SR_VDDBAT5V and LDO_VDDBAT5V supplies.

2. For the LDO_VDD1P5 and WRF_XTAL_VDD1P35 supplies.

3. For the WRF_SYNTH_VDD3P3, WRF_PA_VDD3P3, and WRF_TXMIX_VDD supplies.

4. For WRF_PMU_VDD1P35 and WRF_AFE_VDD1P35 supplies.

5. For the WRF_SYNTH_VDD1P2 supply.

6. For the AVDD1P2 supply.

7. For the VDD supply.

13.2 Environmental Ratings

The environmental ratings are shown in [Table 14.](#page-41-3)

Table 14. Environmental Ratings

13.3 Electrostatic Discharge Specifications

Extreme caution must be exercised to prevent electrostatic discharge (ESD) damage. Proper use of wrist and heel grounding straps to discharge static electricity is required when handling these devices. Always store unused material in its antistatic packaging.

Table 15. ESD Specifications

13.4 Recommended Operating Conditions and DC Characteristics

Caution! Functional operation is not guaranteed outside of the limits shown in [Table 16](#page-41-4). Operation outside these limits for extended periods can adversely affect long-term reliability of the device.

Table 16. Recommended Operating Conditions and DC Characteristics

Table 16. Recommended Operating Conditions and DC Characteristics (Cont.)

1. The CYW43903 is functional across this range of voltages. Optimal RF performance specified in the data sheet, however, is guaranteed only for 3V < VBAT < 4.8V.

2. VDD3P3RF, which is an internally generated supply, can drive this node. There is sufficient current and the appropriate state is maintained during hibernation and sleep cycles.

3. Internally generated supply.

4. Programmable 2 mA to 16 mA drive strength. Default is 10 mA.

13.5 Power Supply Segments

The digital I/O's are placed in physical segments. The supply voltage for each segment can be independently selected.

[Table 17](#page-43-2) shows the power supply segments and the I/O pins associated with each segment.

Table 17. Power Supply Segments

13.6 GPIO, UART, and JTAG Interfaces DC Characteristics

Table 18. GPIO, UART, and JTAG Interfaces

14. WLAN RF Specifications

14.1 Introduction

The CYW43903 includes an integrated direct conversion radio that supports the 2.4 GHz band. This section describes the RF characteristics of the 2.4 GHz radio.

Note: Values in this section of the data sheet are design goals and are subject to change based on device characterization results.

Unless otherwise stated, limit values apply for the conditions specified in [Table 14, "Environmental Ratings,"](#page-41-3) and [Table 16, "Recom](#page-41-4)[mended Operating Conditions and DC Characteristics,"](#page-41-4). Typical values apply for the following conditions:

- $VBAT = 3.6V$
- Ambient temperature +25°C

Figure 12. Port Locations for WLAN Testing

14.2 2.4 GHz Band General RF Specifications

Table 19. 2.4 GHz Band General RF Specifications

14.3 WLAN 2.4 GHz Receiver Performance Specifications

Note: The specification shown in [Table 20](#page-45-1) apply at the chip ports, unless otherwise defined.

Table 20. WLAN 2.4 GHz Receiver Performance Specifications

Table 20. WLAN 2.4 GHz Receiver Performance Specifications (Cont.)

1. Sensitivity degradations for alternate settings in MCS modes. MM: 0.5 dB drop, and SGI: 2 dB drop.

2. The minimum and maximum values shown have a 95% confidence level.

3. –95 dBm with calibration at time of manufacture, –92 dBm without calibration.

14.4 WLAN 2.4 GHz Transmitter Performance Specifications

Note: Unless otherwise noted, the values shown in [Table 21](#page-47-1) apply at the chip ports.

Table 21. WLAN 2.4 GHz Transmitter Performance Specifications

1. This specification row indicates the linear power specification as measured from the chip output port. The requirement is in dBm (TX power). The ratio (dB) in the Conditions/Notes column is the EVM.

2. This specification row indicates the EVM floor. The requirement is in dB (EVM). The power in the Conditions/Notes column is the TX power specification in dBm.

14.5 General Spurious Emissions Specifications

This section provides the TX and RX spurious emissions specifications for the WLAN 2.4 GHz band. The recommended spectrum analyzer settings for the spurious emissions specifications are provided in [Table 22.](#page-48-4)

Table 22. Recommended Spectrum Analyzer Settings

14.5.1 Transmitter Spurious Emissions Specifications

2.4 GHz Band Spurious Emissions

20-MHz Channel Spacing

Note: Possible AFE combinations are as follows. The AFE=VCO/18 specifications for channel 2442 are listed in [Table 23](#page-48-3)

. **Table 23. 2.4 GHz Band, 20-MHz Channel Spacing TX Spurious Emissions Specifications**

14.5.2 Receiver Spurious Emissions Specifications

Table 24. 2G General Receiver Spurious Emissions

15. Internal Regulator Electrical Specifications

15.1 Core Buck Switching Regulator

Note: Values in this data sheet are design goals and are subject to change based on device characterization results.

Note: Functional operation is not guaranteed outside of the specification limits provided in this section.

Table 25. Core Buck Switching Regulator (CBUCK) Specifications

1. The maximum continuous voltage is 4.8V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as
high as 5.0V for up to 250 seconds, cumulative duration, o

2. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

3. Total capacitance includes those connected at the far end of the active load.

15.2 3.3V LDO (LDO3P3)

Table 26. LDO3P3 Specifications

1. The maximum continuous voltage is 4.8V. Voltages up to 6.0V for up to 10 seconds, cumulative duration, over the lifetime of the device are allowed. Voltages as
high as 5.0V for up to 250 seconds, cumulative duration, o

2. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

15.3 CLDO

Table 27. CLDO Specifications

1. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

15.4 LNLDO

Table 28. LNLDO Specifications

1. Minimum capacitor value refers to the residual capacitor value after taking into account the part-to-part tolerance, DC-bias, temperature, and aging.

15.5 BBPLL LDO

Table 29. BBPLL LDO Specifications

16. System Power Consumption

Note: Values in this data sheet are design goals and are subject to change based on the results of device characterization.

Note: Unless otherwise stated, these values apply for the conditions specified in [Table 16, "Recommended Operating Conditions and](#page-41-4) [DC Characteristics,"](#page-41-4).

16.1 WLAN Current Consumption

The tables in this subsection show the typical, total current used by the CYW43903. Current values may be measured with the APPS core powered off. The first column of the table, the mode description, will state the power condition of the APPS core.

16.1.1 2.4 GHz Mode

Table 30. 2.4 GHz Mode WLAN Current Consumption

1. Typical silicon.

2. VIO is specified with all pins idle (not switching) and not driving any loads.

3. REG_ON is low or the device is in hibernation, and all supplies are present.

4. REG_ON is high. APPS domain is powered down. WLAN domain is in low-power state retention mode. Top level is powered up.

5. Inter-beacon current.

6. Beacon Interval = 102.4 ms. Beacon duration = 1 ms @ 1 Mbps. Average current over 3× DTIM intervals.

7. Beacon interval = 307.2 ms. Beacon duration = 1 ms @ 1 Mbps. Average current over 3× DTIM intervals.

8. Duty cycle is 100%. Carrier sense (CS) detect/packet receive.

9. Measured using packet engine test mode.

10. Carrier sense (CCA) when no carrier present.

11. Duty cycle is 100%. TX power at chip output ~17.7 dBm.

12. Duty cycle is 100%. TX power at chip output ~15.2 dBm.

17. SPI Flash Characteristics

17.1 SPI Flash Timing

17.1.1 Read-Register Timing

[Figure 13](#page-55-3) shows the SPI flash extended and quad read-register timing.

Note: Regarding [Figure 13:](#page-55-3) All Read Register commands except Read Lock Register are supported. A Read Nonvolatile Configuration Register operation will output data starting from the least significant byte.

Figure 13. SPI Flash Read-Register Timing

17.1.2 Write-Register Timing

[Figure 14](#page-56-1) shows the SPI flash extended and quad write-register timing.

Note: Regarding [Figure 14:](#page-56-1)

- 1. All write-register commands except Write Lock Register are supported.
- 2. The waveform must be extended for each protocol: to 23 for extended and five for quad.
- 3. A Write Nonvolatile Configuration Register operation requires data being sent starting from the least significant byte.

Figure 14. SPI Flash Write-Register Timing

17.1.3 Memory Fast-Read Timing

[Figure 15](#page-57-1) shows the SPI flash extended and quad memory fast-read timing.

Note: Regarding [Figure 15:](#page-57-1)

- 1. 24-bit addressing is used, so A[MAX] = A[23] and A[MIN] = A[0].
- 2. For an extended SPI protocol, $C_x = 7 + (A[MAX] + 1)$.
- 3. For a quad SPI protocol, $C_x = 1 + (A[MAX] + 1)/4$.

Figure 15. Memory Fast-Read Timing

17.1.4 Memory-Write Timing

[Figure 16](#page-58-1) shows the SPI flash extended and quad memory-write (Page Program) timing.

Note: Regarding [Figure 16:](#page-58-1)

- 1. For an extended SPI protocol, $C_x = 7 + (A[MAX] + 1)$.
- 2. For a quad SPI protocol, $C_x = 1 + (A[MAX] + 1)/4$.

17.1.5 SPI Flash Parameters

The combination of [Figure 17](#page-59-1) and [Table 31](#page-59-2) provide the SPI flash timing parameters.

Table 31. SPI Flash Timing Parameters

18. Power-Up Sequence and Timing

18.1 Sequencing of Reset and Regulator Control Signals

The CYW43903 has two signals that allow the host to control power consumption by enabling or disabling the internal regulator blocks. These signals are described below. Additionally, diagrams are provided to indicate proper sequencing of the signals for various operational states (see [Figure 18](#page-60-4) and [Figure 19](#page-60-5)). The timing values indicated are minimum required values; longer delays are also acceptable.

18.1.1 Description of Control Signals

- **REG_ON**: Used by the PMU to power-up the CYW43903. It controls the internal CYW43903 regulators. When this pin is high, the regulators are enabled and the device is out of reset. When this pin is low the regulators are disabled.
- **HIB_REG_ON_IN**: Used by the Hibernation (HIB) block to power up the internal CYW43903 regulators. If the HIB_REG_ON_IN pin is low, the regulators are disabled. For the HIB_REG_ON_IN pin to work as designed, HIB_REG_ON_OUT must be connected to REG_ON.

Note: The CYW43903 has an internal power-on reset (POR) circuit. The device will be held in reset for a maximum of 110 ms after VDDC and VDDIO have both passed the POR threshold.

Note: The 10%–90% VBAT rise time should not be faster than 40 microseconds. VBAT should be up before or at the same time as VDDIO. VDDIO should not be present first or be held high before VBAT is high.

18.1.2 Control Signal Timing Diagrams

Figure 19. HIB_REG_ON_IN = High, HIB_REG_ON_OUT Connected to REG_ON

19. Thermal Information

19.1 Package Thermal Characteristics

Table 32. Package Thermal Characteristics¹

1. No heat sink, TA = 70°C. This is an estimate based on a 4-layer PCB that conforms to EIA/JESD51-7. Air velocity is 0 m/s.

19.2 Junction Temperature Estimation and PSI_{JT} Versus THETA_{JC}

Package thermal characterization parameter PSI―J $_\mathsf{T}$ (φ_JT) yields a better estimation of actual junction temperature (T $_\mathsf{J}$) versus using the junction-to-case thermal resistance parameter Theta–J_C ($\theta_{\rm JC}$). The reason for this is that $\theta_{\rm JC}$ assumes that all the power is dissipated through the top surface of the package case. In actual applications, some of the power is dissipated through the bottom and sides of the package. γ_{IT} takes into account power dissipated through the top, bottom, and sides of the package. The equation for calculating the device junction temperature is:

 $TJ = TT + P x YJT$

Where:

- \blacksquare T_J = Junction temperature at steady-state condition (°C)
- T_T = Package case top center temperature at steady-state condition (°C)
- \blacksquare P = Device power dissipation (Watts)
- \blacksquare \mathcal{Y}_{JT} = Package thermal characteristics; no airflow (°C/W)

19.3 Environmental Characteristics

For environmental characteristics data, see [Table 14, "Environmental Ratings,".](#page-41-3)

20. Mechanical Information

21. Ordering Information

22. Additional Information

22.1 Acronyms and Abbreviations

In most cases, acronyms and abbreviations are defined upon first use. For a more complete list of acronyms and other terms used in Cypress documents, go to:<http://www.cypress.com/glossary>.

22.2 IoT Resources

Cypress provides a wealth of data at [http://www.cypress.com/internet-things-iot t](http://www.cypress.com/internet-things-iot)o help you to select the right IoT device for your design, and quickly and effectively integrate the device into your design. Cypress provides customer access to a wide range of information, including technical documentation, schematic diagrams, product bill of materials, PCB layout information, and software updates. Customers can acquire technical documentation and software from the Cypress Support Community website ([https://community.cypress.com/\)](https://community.cypress.com/)

22.3 Errata

1. The RTC block has been deprecated from this datasheet in revision *A and later. This block is used by Cypress for internal testing/validation/verification and is not intended for customers to use.

2. The details of the SPI hardware blocks was not available in revision *E and [5.7 SPI](#page-19-0) has been added in Revision *F. Note that the SPI hardware blocks can only support a hold time of 25ns and a fixed SPI mode (CPHA=0, CPOL = 0). For slaves that require higher hold times or a different mode, a bit banging based SPI driver is recommended.

3. The clock for the SPI Flash block needs to be constrained to ~26.67MHz for reliable operation at high operating temperatures. The throughput of the SPI Flash block is therefore restricted to ~13 MBps for Quad mode and ~3 MBps for single mode

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